

AO3422

N-Channel Enhancement Mode Field Effect Transistor

General Description

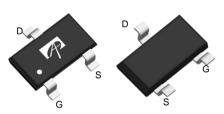
The AO3422 uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$ and low gate charge. It offers operation over a wide gate drive range from 2.5V to 12V. This device is suitable for use as a load switch.

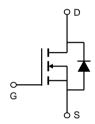
Features

$$\begin{split} &V_{DS}\left(V\right) = 55V \\ &I_{D} = 2.1A \ \ (V_{GS} = 4.5V) \\ &R_{DS(ON)} < 160m\Omega \left(V_{GS} = 4.5V\right) \\ &R_{DS(ON)} < 200m\Omega \left(V_{GS} = 2.5V\right) \end{split}$$



SOT23
Top View Bottom View





Absolute Maximum Ratings T_A=25°C unless otherwise noted Symbol Maximum Units Parameter Drain-Source Voltage V_{DS} 55 Gate-Source Voltage V_{GS} ±12 ٧ T_A=25°C Continuous Drain 2.1 Current A T_A=70°C 1.7 Α I_D Pulsed Drain Current 10 I_{DM} T_A=25°C 1.25 P_D W T_A=70°C 8.0 Power Dissipation °C Junction and Storage Temperature Range T_J, T_{STG} -55 to 150

Thermal Characteristics									
Parameter		Symbol	Тур	Typ Max Unit					
Maximum Junction-to-Ambient A	t ≤ 10s	D	75	100	°C/W				
Maximum Junction-to-Ambient A	Steady-State	$R_{\theta JA}$	115	150	°C/W				
Maximum Junction-to-Lead ^C	Steady-State	$R_{ heta JL}$	48	60	°C/W				



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Parameter Conditions		Min	Тур	Max	Units
STATIC F	PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I _D =10mA, V _{GS} =0V		55			V
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} =44V, V_{GS} =0V				1	μА
	Zero Gate Voltage Brain Gurrent		T _J =55°C			5	μΑ
I _{GSS}	Gate-Source leakage current	V_{DS} =0V, V_{GS} =±12V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ $I_{D}=250\mu A$		0.6	1.3	2	V
I _{D(ON)}	On state drain current	V_{GS} =4.5V, V_{DS} =5V		10			Α
R _{DS(ON)}		V _{GS} =4.5V, I _D =2.1A			125	160	mΩ
	Static Drain-Source On-Resistance		T _J =125°C		175	210	
		V _{GS} =2.5V, I _D =1.5A			157	200	mΩ
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =2.1A			11		S
V_{SD}	Diode Forward Voltage	I _S =1A			0.78	1	V
Is	Maximum Body-Diode Continuous Curre			1	Α		
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =25V, f=1MHz			214	300	pF
C _{oss}	Output Capacitance				31		pF
C _{rss}	Reverse Transfer Capacitance				12.6		pF
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz			1.3	3	Ω
SWITCHI	NG PARAMETERS						
Q_g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =27.5V, I _D =2.1A			2.6	3.3	nC
Q_{gs}	Gate Source Charge				0.6		nC
Q_{gd}	Gate Drain Charge				0.8		nC
t _{D(on)}	Turn-On DelayTime				2.3		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =27.5V, R_L =12 Ω , R_{GEN} =3 Ω			2.4		ns
t _{D(off)}	Turn-Off DelayTime				16.5		ns
t _f	Turn-Off Fall Time				2		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =2.1A, dI/dt=100A/μs			20	30	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =2.1A, dI/dt=100A/μs			17		nC

A: The value of R $_{0JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25 $^\circ$ C. The value in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta,JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta,JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using <300 µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T_A=25° C. The SOA curve provides a single pulse rating.



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

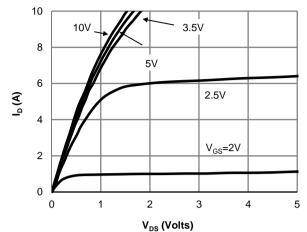
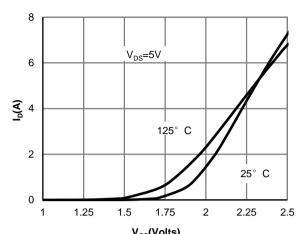
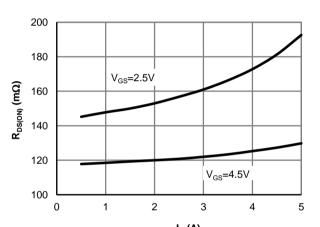


Fig 1: On-Region characteristics



V_{GS}(Volts)
Figure 2: Transfer Characteristics



 $\rm I_D$ (A) Figure 3: On-Resistance vs. Drain Current and Gate Voltage

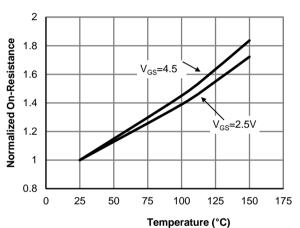


Figure 4: On-Resistance vs. Junction Temperature

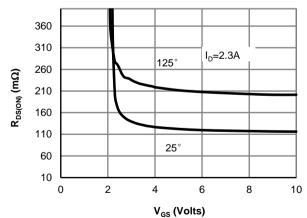
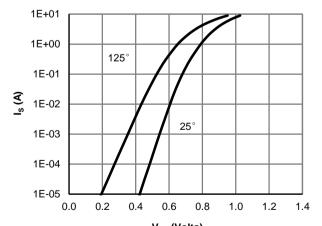


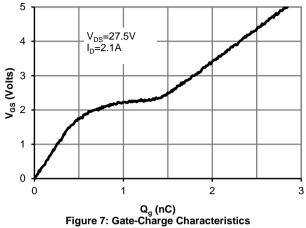
Figure 5: On-Resistance vs. Gate-Source Voltage

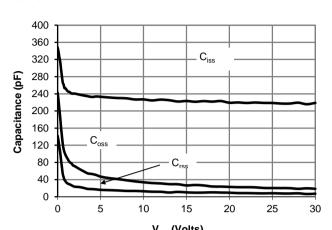


V_{SD} (Volts) Figure 6: Body-Diode Characteristics



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





V_{DS} (Volts)
Figure 8: Capacitance Characteristics

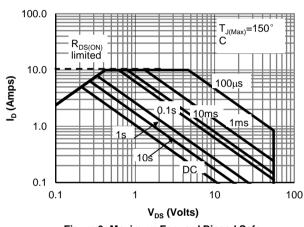
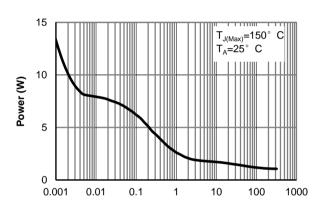


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)



Pulse Width (s)
Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

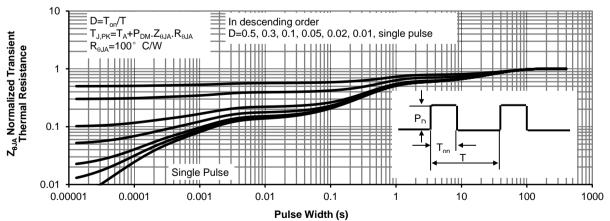
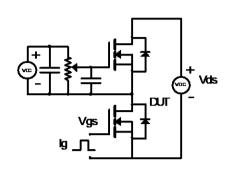
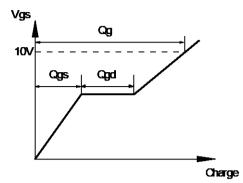


Figure 11: Normalized Maximum Transient Thermal Impedance

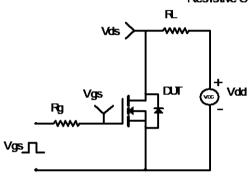


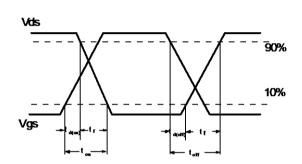
Gate Charge Test Circuit & Waveform

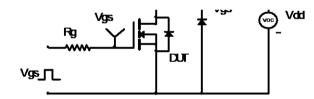


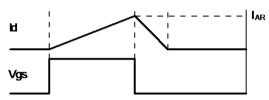


Resistive Switching Test Circuit & Waveforms









Diode Recovery Test Circuit & Waveforms

